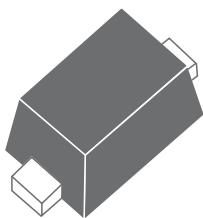
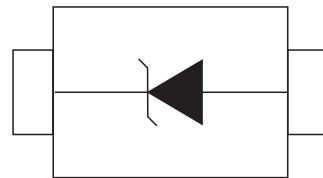


Electro-Static Discharge TESD12EU Unidirectional TVS Diode

SOD-523



Pin Configuration



Features

- 150 Watts Peak Pulse Power per Line ($t_p=8/20\mu s$)
- Protects one I/O line
- Low clamping voltage
- Working voltages :12V
- Low leakage current

IEC Compatibility

- IEC61000-4-2 (ESD) $\pm 15kV$ (air), $\pm 8kV$ (contact)
- IEC61000-4-4 (EFT) 40A (5/50 ηs)

Applications

- Cellular Handsets and Accessories
- Portable Electronics
- Industrial Controls
- Set-Top Box
- Instrumentation
- Servers, Notebook, and Desktop PC
- Display Ports

Mechanical Characteristics

- SOD-523 Package
- Molding Compound Flammability Rating:L 94V-O
- Quantity Per Reel:5000pcs
- Reel Size:7 inch
- Lead Finish:Lead Free

Maximum Ratings($T_A=25^\circ\text{C}$ unless otherwise noted)

Maximum Ratings(@25°C Unless Otherwise Specified)			
Parameter	Symbol	Value	Units
Peak Pulse Power(tp=8/20μs waveform)	P _{PP}	150	Watts
Lead Soldering Temperature	T _L	260(10 sec.)	°C
Operating Temperature Range	T _J	-55~150	°C
Storage Temperature Range	T _{STG}	-55~150	°C

Electrical Characteristics($T_a=25^\circ\text{C}$ unless otherwise specified)

TESD12EU(Marking:ZM)					
Parameter	Symbol	Conditions	Min.	Max.	Units
Reverse Stand-off Voltage	V _{RWM}			12	V
Breakdown Voltage	V _{BR}	I _T =1mA	13.3		V
Clamping Voltage	V _C	I _{PP} =1A,tp=8/20μs		16.5	V
		I _{PP} =6A,tp=8/20μs		28	V
Reverse Leakage Current	I _R	@V _{RWM}		1	μA
Junction Capacitance	C _{I/O}	0Vdc,f=1MHz Between I/O Pins and GND		60	pF

Ratings and Characteristic Curves

Fig.1 Power Derating Curve

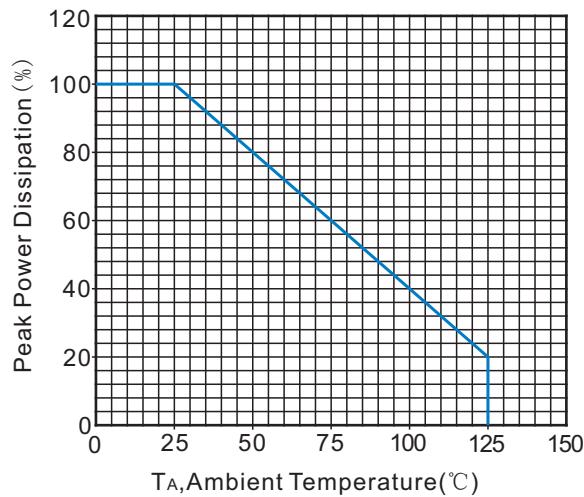
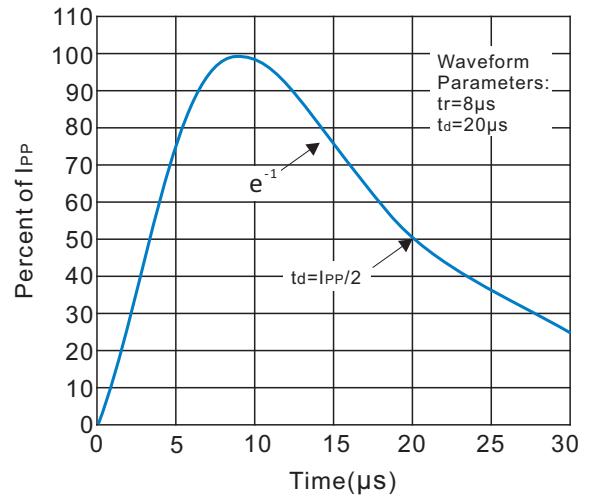
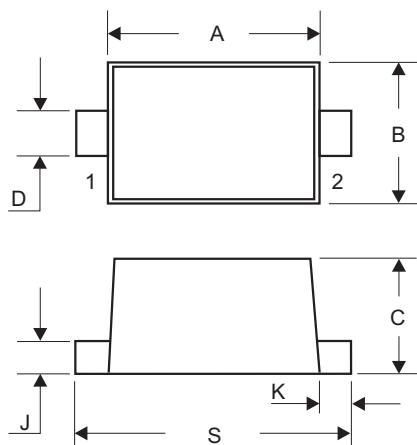


Fig.2 Pulse Waveform



Dimensions(SOD-523)

SOD-523



DIM	Millimeters		Inches	
	Min	Max	Min	Max
A	1.10	1.30	0.043	0.051
B	0.70	0.90	0.028	0.035
C	0.50	0.70	0.020	0.028
D	0.25	0.35	0.010	0.014
J	0.07	0.20	0.0028	0.0079
K	0.15	0.25	0.006	0.010
S	1.50	1.70	0.059	0.067

Recommended Mounting Pad Layout

